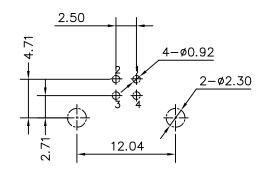


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USB-PCB LAYOUT

NOTES:

1.MATERIAL:

TERMINAL-C5191 PHOSPHOR BRONZE HARD.

SHIELD-COPPER ALLOY

HOUSING-PBT+30% G.F. UL94V-0

2.PLATING: CONTACT-GOLD PLATING OVER NICKEL

TERMINAL-75u" Tin MIN OVER 50u"-100u" NICKEL 12

SHIELD-120u" TIN MIN OVER 50u" NICKEL. OR 100u"~120u" NICKEL OVER 40u" Cu.

3.GAP. 0.25mm (Max.)

4.ELECTRICAL:

VOLTAGE RATING : 30 VAC RMS.

CURRENT RATING : 1.0 AMP

CONTACT RESISTANCE : 30 MILLIOHMS MAX

INSULATION RESISTANCE : 1000 MEGOHMS MIN @500 VDC

DIELETRIC STRENGTH : 750 VAC RMS 60 HZ, 1 MIN

OPERATING LIFE : 1500 CYCLES MIN

MATING FORCE : 3.5 KGS MAX

UNMATING FORE : 1 KGS MIN

5.NVIRONMENTAL:

STORAGE : −40°C TO +85°C

OPERATION : -40°C TO +85°C

CAPACITANCE : 2 PF MAX 1KHZ

WAVE SOLDER TEMPERATURE: 230-250°C.(3-5 SECONDS)

RoHS COMPLIANT

6.UL & CUL FILE NO. E163191 OLD DRAWING NUMBER: GE813A02-LC

ROHS P/N	REV	MATERIAL	SHIELD PLATING	PLATING
E8144-B02022-L	Α	PBT BLACK	PLATING TIN	Au6u"

DETACHED LISTS	MM (INCH) TOLERANCES EXCEPT AS NOTED		DFTO SAMMY DATE 03/14,			Pulse Electronics	RoHS Compliant			
	MM		CHKD ALICE	DATE 3/29/20	29/2012 Electronic					
	.00 ± 0.20 .00 ± 0.15 .000 ± 0.075	±	APPVL TIM	DATE 3/29/20	12	TITLE		USB S	eries	В
		± ±	MATERIAL :		4-Position Dip Type					
	ANGLES ± 0.5°		QT'Y:		DRAWING NO. E8144-BO			SIZE	REV	
			FINISH:		/PART NO. E8144-B0XX2X-L			A3 13		
			SCALE : 3:1		DO NOT SCALE DRAWING		SHEET '	OF	1	
	4		3			2		1		